

Gold Bonding Wire (Au100) Gold 20um (0.8mil)

Product Highlights

High Purity Gold > 99.99% (4N)
Designed specifically for wire bonding

Specifications

Alloy:	Au100
Melting Point:	1,064°C (1,947°F)
Packaging:	Spool
Diameter:	20µm (0.8 mil)
Length:	100m (328 feet)
Shelf Life:	> 12 months
Purity:	4N (>99.99%)



Storage and Handling

Store in a dry non-corrosive environment.

Transportation

This product has no shipping restrictions.

Test Results

Test J-STD-004 or other requirements as stated	Test Requirement	Result
Conflict Minerals Compliance	Electronic Industry Citizenship Coalition (EICC)	Compliant
REACH Compliance	Articles 33 and 67 of Regulation (EC) No 1907/2006	Compliant

Conforms to the following Industry Standards:

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders):	Yes
RoHS 3 Directive (EU) 2015/863:	Yes

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